

PRODUCT FEATURES

PROPERTIES	EVA	PLANAMELT	PUR
Adhesive application	0.5-1 mm	0.2-0.7 mm	0.2-0.5 mm
Layflat	Medium to high stapling effect, pronounced bond coat	Low to medium stapling effect, positive effect on layflat characteristics, very good degree of flatness	Medium to high stapling effect normal layflat characteristics
Service life	Low	High	High
Temperature resistance	Low resistance to heat, poor performance at low temperatures	High resistance to heat as well as good low-temperature characteristics	High resistance to heat as well as good low-temperature characteristics
Durability	Usually sufficient pull resistance values	Good to very good pull resistance values	Good to very good pull resistance values
Versatility	Not suitable for heavy, coated papers	Suitable for virtually all conventional paper types	Suitable for all conventional paper types
Environment	No isocyanates in processing, generally easily recyclable	No isocyanates in processing, easy to use and eco-friendly, easily recyclable	Isocyanates used in adhesive production and processing, easily recyclable
Price/performance	High product requirement due to higher applied quantities, rapid charring of the adhesive in the systems, higher cleaning effort	Low process costs, simple melting apparatus sufficient, reduced cleaning effort, increased process stability. Using Planamelt, assignments can be taken on which would otherwise require investment in a PUR system.	High adhesive and process costs, complex machine and system technology as well as increased handling effort, as PUR requires air humidity for its chemical reaction.
Overall rating	EVA hotmelts are suitable for simple applications without any special requirements with regard to temperatures, physical loads or layflat characteristics. They are less suited to dealing with difficult paper types and develop a high stapling effect with books.	PLANAMELT is designed for universal use, copes well with difficult paper types and is suitable for all binding work. PLANAMELT ensures process reliability, is free from isocyanate and easily recyclable. A high level of cost-efficiency is achieved thanks to the low applied quantity and the reduced maintenance and cleaning effort on the machines.	PUR has high bonding strengths, but is "overqualified" for more simple paper types. Complex machinery and systems are required. The chemical reaction with air humidity and the contained isocyanates has disadvantages in terms of process control.

Adhesive binding with Planamelt - outstanding!



PLANAMELT

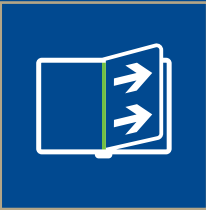
A whole new league for binding adhesives



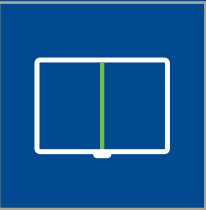
No additional expenditure
Works in existing hotmelt systems not reactive systems



Low consumption
Thin adhesive application



Very strong bond
High pull resistance value even on difficult paper types



Layflat binding
Excellent layflat characteristics



A whole new league for binding adhesives

PLANAMELT

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As at: 2024

All statements in this product information are based on our experience and knowledge. It is essential that the user tests the selected adhesives for suitability for the intended application, especially under the influence of his own production conditions and the substrates used. The information contained herein does not constitute a guarantee of properties within the meaning of the current BGH (Federal Court of Justice) case law and is therefore not binding. Information on product details and safety can be found in the respective technical data sheets and safety data sheets.

PLANATOL®
smart gluing

PLANAMELT at a glance

PLANAMELT Pro

- For gluing off thread-bound brochures
- Good rounding characteristics
- Very high adhesive strength on lacquered surfaces
- Also suitable for standard adhesive binding
- Even shorter open time than Planamelt W
- Also available as Pro W

PLANAMELT HSP II

- Specifically developed for very short processing lines
- Very short open time
- For small perfect binders
- Especially for digital printing and short runs

PLANAMELT HC

- All-rounder for bookbinding
- high clamping effect
- high adhesion to the sheet edges

PLANAMELT S

- Side glue & endpaper adhesion
- Outstanding adhesive strength on difficult surfaces

Due to the different substrates and requirements, pre-tests are essential. Please contact our technical support if you have any questions. This is only an excerpt from our extensive product portfolio. We will be happy to advise you personally and individually to find the most suitable adhesive for you and your application.

PLANAMELT R

- All-rounder for adhesive binding
- Very high adhesive strength
- Outstanding durability of adhesive binding
- Can also be used as side glue

PLANAMELT LT

- Developed for processing in PUR application systems, specially for small perfect binders
- LT= Low Temperature- already applicable at a low processing temperature

PLANAMELT W

- Similar properties to Planamelt R
- Even better cohesion than Planamelt R
- Slightly shorter open time than Planamelt R
- White pigmented

PLANAMELT SL23

- Side glue & endpaper bonding
- Softly adjusted
- Good adhesion even on regular photo paper

The all-rounder among adhesives

Planamelt is a hotmelt technology that has been especially developed for the requirements of the graphic arts industry – making it the first choice when it comes to the adhesive binding and side glueing of all print products. The simple and convenient processing and the high quality of the adhesive binding speak for themselves. Heavy grade papers and grammages up to 250 g/m² can be processed reliably and cleanly with Planamelt. The result is clear for all to see: excellent cohesiveness of the adhesive binding, superb layflat characteristics, high stability with regard to heat, viscosity and adhesive properties.

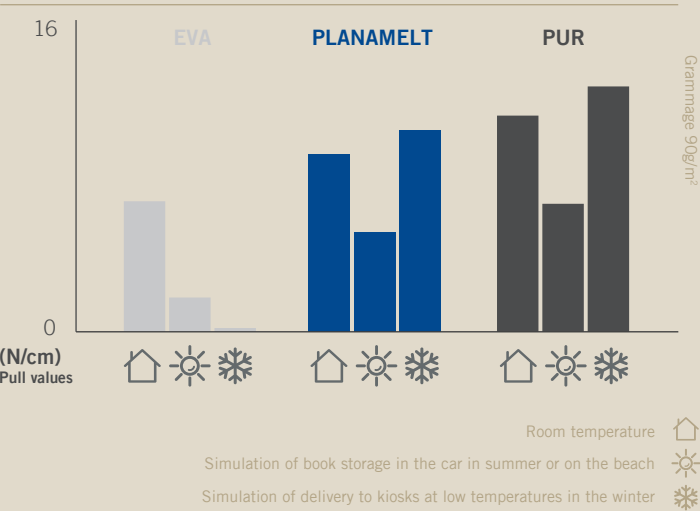
Digital is now

PLANAMELT is the ideal solution for digital printing. Digital presses either work with toner or silicones. The problem with conventional EVA hotmelts is that they do not stick well on paper that is coated with toner or traces of silicone oil. As Planamelt does not, unlike PUR adhesives, require any ambient humidity for reaction purposes, a higher level of process reliability is ensured. Choosing PLANAMELT means being optimally equipped for the future: It is possible to combine different paper grades and grammages, and even foils, without having to change the adhesive. Individual printing, variable compilation and personalised finish.

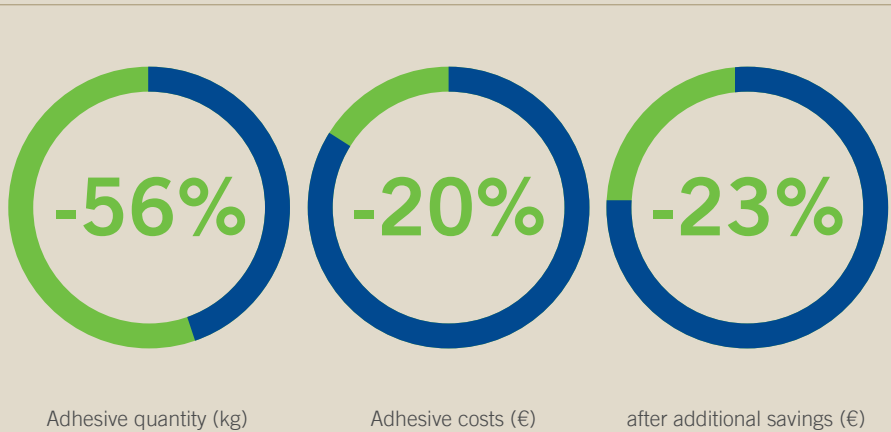
PLANAMELT: the advantages of EVA and PUR adhesives in a single system

- Can be used for virtually all paper types and foils
- Low applied quantities
- Outstanding binding quality
- Highly resilient to heat and cold
- Good thermal stability of the melt
- Isocyanate-free, without special labelling
- Impressive layflat characteristics
- Quick and simple further processing
- Reduced costs for maintenance and replacement parts
- Virtually odourless
- Low process costs

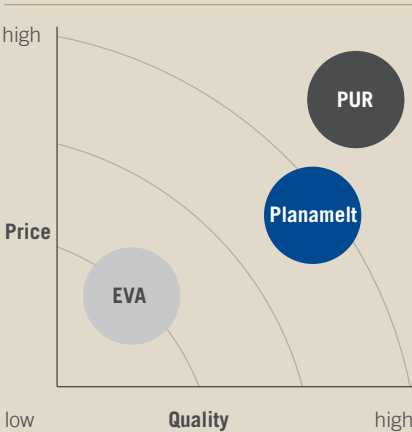
PLANAMELT is resilient to heat and cold



PLANAMELT reduces costs



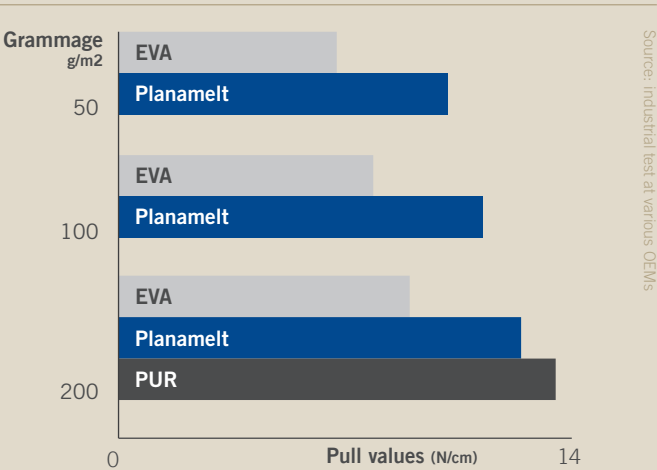
Price/performance



Comparison of applied quantities



Pull resistance values



Source: industrial test at various OEMs

PLANAMELT

Adhesive bindings with Planamelt require less adhesive than with conventional EVA adhesives

EVA

The benefits of Planamelt technology have been confirmed in industrial tests by machine manufacturers as well as in a study by the University of Applied Sciences in Munich.

In a test procedure with various paper grammages, Planamelt achieved consistently higher pull resistance values in direct comparison with the tested EVA technology. With a grammage of 200 g/m², the cohesiveness of the adhesive binding was almost the same quality as a PUR adhesive.

Compared with EVA adhesives, Planamelt not only offers better adhesive properties but is also the better choice in economical terms thanks to the lower applied quantities. Planamelt also has advantages over the typical PUR technology due to the considerably lower price and process costs as well as its universal use and better process control.